

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

_____ is attached hereto
 _____ was filed on _____ as Application Serial No. _____
 _____ and was amended on _____ (if applicable).
☒ I hereby authorize and request our attorney, Davidson, Davidson & Kappel, LLC. of 485 Seventh Avenue, 14th Floor, New York, New York 10018 to insert here in parentheses (Application number _____, filed _____) the filing date and application number of said application when known.

I acknowledge the duty to disclose all information which is known to me to be material to the patentability of this application as defined in Title 37, Code of Federal Regulations, §1.56.

PRIOR APPLICATION(S) <u>102 50 761.9</u> (Number)	<u>Germany</u> (Country)	<u>October 31, 2002</u> (Day/Month/Year Filed)	<u>X</u> Yes	<u> </u> No
<u> </u> (Number)	<u>Germany</u> (Country)	<u> </u> (Day/Month/Year Filed)	Yes	No
<u> </u> (Number)	<u> </u> (Country)	<u> </u> (Day/Month/Year Filed)	Yes	No

(Application Serial Number) (Filing Date) (Status) (patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of joint
Inventor, if any

Second Inventor's signature _____
Date _____
Residence _____
Citizenship _____
Post Office Address: _____

Full name of joint
Inventor, if any

Fourth Inventor's signature _____
Date _____
Residence _____
Citizenship _____
Post Office Address _____